

Innovating Energy Technology

http://www.fujielectric.com/products/semiconductor/ **FUJI POWER MOSFET**

Super J-MOS series

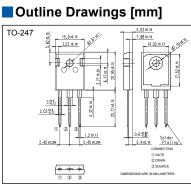
N-Channel enhancement mode power MOSFET

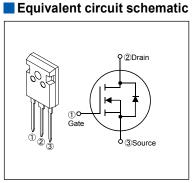
Features

Pb-free lead terminal **RoHS** compliant uses Halogen-free molding compound

Applications

For switching





Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Drain Source Voltage	VDS	600	V	
Drain-Source Voltage	VDSX	600	V	V _{GS} =-30V
Continuous Drain Current	lo	±30	А	Tc=25°C Note*1
		±19	А	Tc=100°C Note*1
Pulsed Drain Current	IDP	±90	А	
Gate-Source Voltage	V _{GS}	±30	V	
Repetitive and Non-Repetitive Maximum Avalanche Current	lar	6.6	А	Note *2
Non-Repetitive Maximum Avalanche Energy	Eas	849.2	mJ	Note *3
Maximum Drain-Source dV/dt	dV _{DS} /dt	50	kV/μs	V _{DS} ≤ 600V
Peak Diode Recovery dV/dt	dV/dt	12	kV/μs	Note *4
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note *5
Maximum Bowar Discinction	P	2.5	w	T₂=25°C
Maximum Power Dissipation	FD	220	vv	Tc=25°C
Operating and Starage Temperature range	Tch	150	°C	
Operating and Storage Temperature range	T _{stg}	-55 to +150	°C	

Note *1 : Limited by maximum channel temperature. Note *2 : Tch≤150°C, See Fig.1 and Fig.2 Note *3 : Starting Tch=25°C, I₄s=4A, L=97.3mH, Vpp=60V, Rg=50Ω, See Fig.1 and Fig.2

EAs limited by maximum channel temperature and avalanche current. Note *4 : Ir≤-ID, -di/dt=100A/µs, VbD≤400V, Tch≤150°C.

Note *5 : IF≤-ID, dV/dt=12kV/µs, VDD≤400V, Tch≤150°C.

Electrical Characteristics at T_c=25°C (unless otherwise specified) Static Ratings

Parameter	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	I₀=250μA V₅s=0V		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	I₀=250µA V₀s=V₀s		2.5	3.0	3.5	V
Zero Gate Voltage Drain Current	IDSS	V _{DS} =600V V _{GS} =0V	T _{ch} =25°C	-	-	25	μA
		V _{DS} =480V V _{GS} =0V	T _{ch} =125°C	-	-	250	
Gate-Source Leakage Current	lass	V _{GS} = ± 30V V _{DS} =0V		-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	I₀=15A V₀s=10V		-	0.106	0.125	Ω
Gate resistance	RG	f=1MHz, open drain		-	3.2	-	Ω

Dynamic Ratings

Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	g _{fs}	I _D =15A V _{DS} =25V	13	26	-	S
Input Capacitance	Ciss	V _{DS} =10V	-	2200	-	
Output Capacitance	Coss	V _{GS} =0V	-	4670	-	
Reverse Transfer Capacitance	Crss	f=1MHz	-	430	-	
Effective output capacitance, energy related (Note *6)	C _{o(er)}	V _{GS} =0V V _{DS} =0480V	-	127	-	pF
Effective output capacitance, time related (Note *7)	C _{o(tr)}	V _{GS} =0V V _{DS} =0480V ID=constant	-	450	-	
Turne On Times	t _{d(on)}		-	31	-	
Turn-On Time	tr	V _{DD} =400V, V _{GS} =10V I _D =15A, R _G =13Ω See Fig.3 and Fig.4	-	57	-	ns
Turn-Off Time	t _{d(off)}		-	136	-	
Turn-Off Time	tr		-	17	-	
Total Gate Charge	Q _G	V₀₀=480V, I₀=30A V₀₅=10V See Fig.5	-	73	-	nC
Gate-Source Charge	Q _{GS}		-	18	-	
Gate-Drain Charge	Q _{GD}		-	25	-	
Drain-Source crossover Charge	Qsw		-	11.5	-	

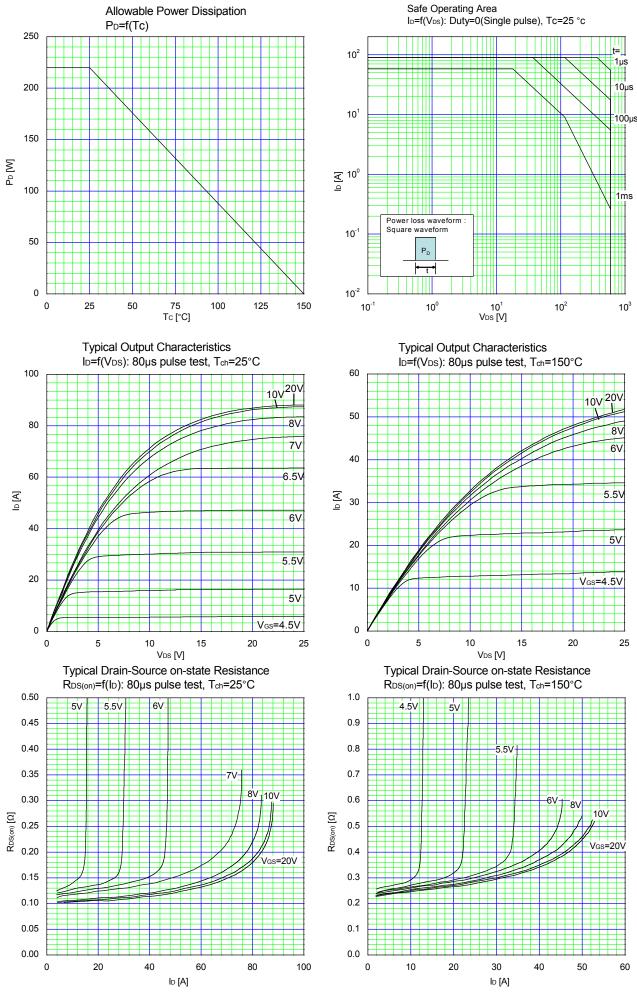
Note *6 : $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{Ds} is rising from 0 to 80% BV_{Dss}. Note *7 : $C_{o(tr)}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{Ds} is rising from 0 to 80% BV_{Dss}.

Reverse Diode

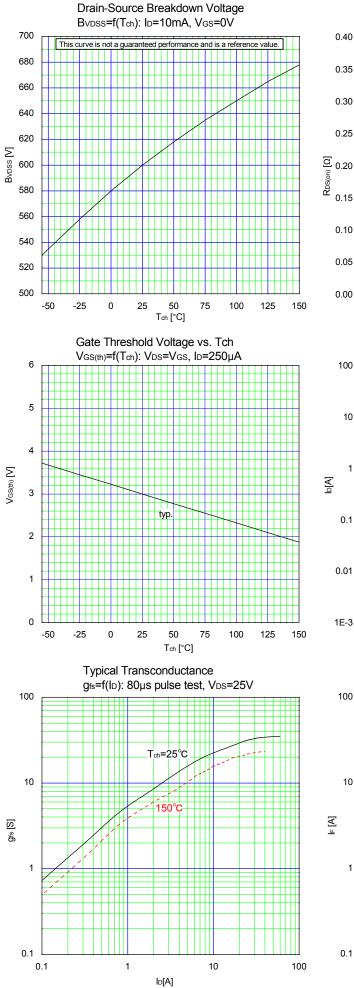
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Avalanche Capability	lav	L=21.7mH, T₀ =25°C See Fig.1 and Fig.2	6.6	-	-	А
Diode Forward On-Voltage	V _{SD}	I _F =30A, V _{GS} =0V T _{ch} =25°C	-	0.9	1.35	V
Reverse Recovery Time	trr	I⊧=30A, V₀s=0V V₀p=400V -di/dt=100A/µs T₅h=25°C See Fig.6		430	-	ns
Reverse Recovery Charge	Qrr		-	8.6	-	μC
Peak Reverse Recovery Current	Irp		-	38	-	А

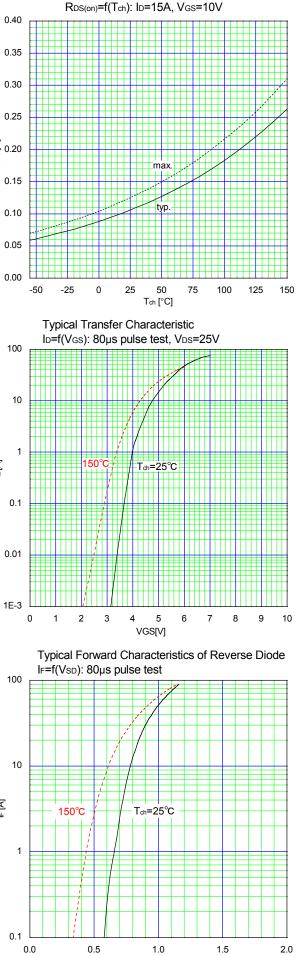
Thermal Resistance

Parameter	Symbol	min.	typ.	max.	Unit
Channel to Case	R _{th(ch-c)}	-	-	0.57	°C/W
Channel to Ambient	R _{th(ch-a)}	-	-	50	°C/W

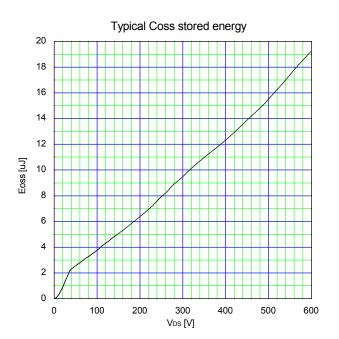


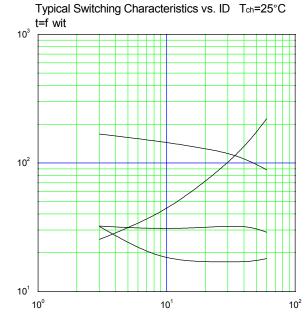
Drain-Source On-state Resistance



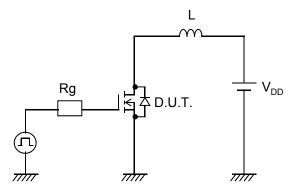


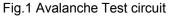
Vsd [V]





5





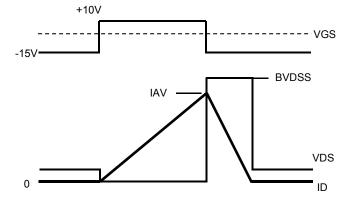


Fig.2 Operating waveforms of Avalanche Test

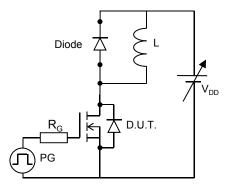


Fig.3 Switching Test circuit

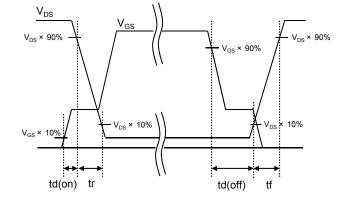


Fig.4 Operating waveform of Switching Test

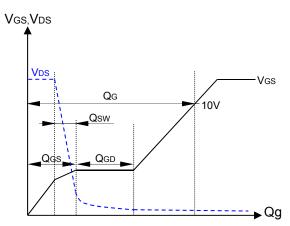


Fig.5 Operating waveform of Gate charge Test

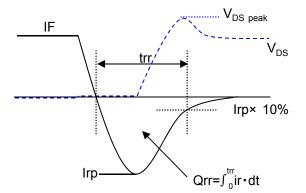
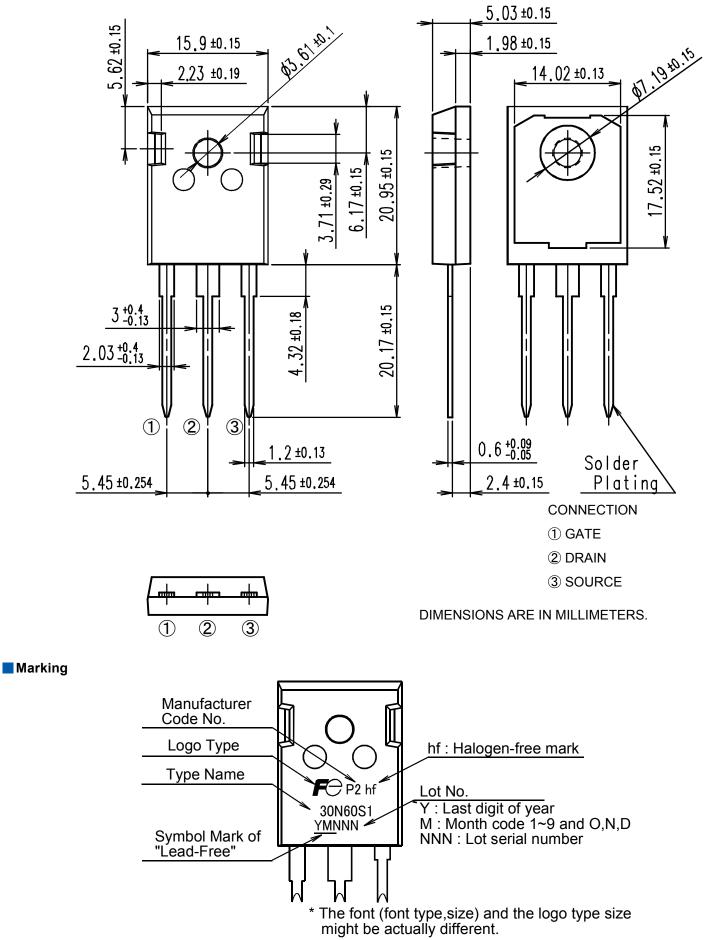


Fig.6 Operating waveform of Reverse recovery Test

Outview: TO-247 Package



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